



LOCTITE.

AMERICAS

UNITED STATES

Henkel Corporation 14000 Jamboree Road United States Tel: +1.888.943.6535 Fax: +1.714.368.2265

Henkel Corporation 20021 Susana Road Rancho Dominguez, CA 90221 United States
Tel: +1.310.764.4600

Henkel Corporation 18930 W. 78th Street Chanhassen, MN 55317 United States Tel: +1.952.835.2322 Tel: +1.800.347.4572 Fax: +1.952.835.0430

BRAZIL Henkel Brazil

Av. Prof. Vernon Krieble, 91 06690-070 Itapevi, Sao Paulo Fax: +55.11.3205.7100

ASIA-PACIFIC

CHINA

Henkel Management Center Building 7, No. 99 Jiang Wan Cheng Road Shanghai 200438, Tel: +86.21.2891.8000 Fax: +86.21.2891.8952

EUROPE

BELGIUM

Henkel Belgium N.V.

Nijverheidsstraat 7

Fax: +32.1458.5530

UNITED KINGDOM

Adhesives Limited Technologies House

Henkel Ltd.

Wood Lane End

United Kingdom Tel: +44.1442.278000

Hemel Hempstead Hertfordshire HP2 4RQ

Fax: +44.1442.278071

Across the Board, Around the Globe.

henkel-adhesives.com/electronics

B-2260 Westerlo Belgium Tel: +32.1457.5611

ABLESTIK (Shanghai) LIMITED No. 332 Meigui South Road WaiGaoQiao Free Trade Zone, Pu Dong Shanghai 200131, China Tel: +86.21.2702.5888

Fax: +86.21.5048.4169

JAPAN Henkel Japan Ltd. 27-7, Shin Isogo-cho Isogo-ku Yokohama, 235-0017 Japan Tel: +81.45.286.0161 Email: jp.ae-csdesk@henkel.com

Henkel Korea Co Ltd.
18th Floor of tower B, BYC High City Bldg
Gasan Digital 1-ro, Geumcheon-gu,
Seoul, 08506 South Korea Tel: +82.2.6150.3000 Fax: +82.2.6947.5203

SINGAPORE

Henkel Singapore Pte Ltd. 401, Commonwealth Drive #03-01/02 Haw Par Technocentre, Singapore 149598 Tel: +65.6266.0100 Fax: +65.6472.8738 / +65.6266.1161

TAIWAN

Henkel Taiwan Ltd. 10F, No. 866, Zhongzheng Road, Zhonghe District, New Taipei City, 23586 Tel: +866.2.2227.1988 Fax: +866.2.2226.8699

Except as otherwise noted, all marks are trademarks and/or registered trademarks of Henkel and/or its affiliates in the U.S. and elsev © 2019 Henkel Corporation. All rights reserved. 14764/ LT-6742 (10/19) A4

LOCTITE.

Materials for

MICRO-ELECTRO-MECHANICAL SYSTEMS (MEMS)





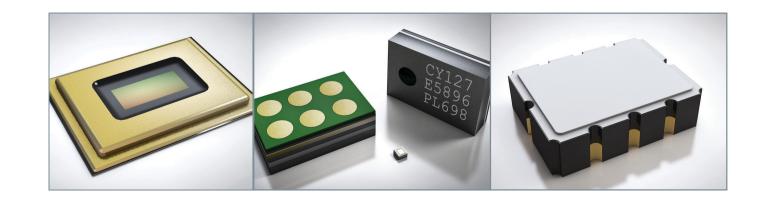


MEMS

Henkel Advantage

When one considers the average smartphone contains approximately eight to 10 MEMS – a number which is projected to grow in the coming years – one gets a sense for the breadth of MEMS applications. The ability to design, test and commercialize new MEMS devices quickly is critical to a MEMS manufacturer's market competitiveness. In order to meet the average three-to-six month cycle time, MEMS manufacturers need to leverage proven materials solutions that are market-ready, market-tested and supported globally to facilitate multi-site design and manufacturing.

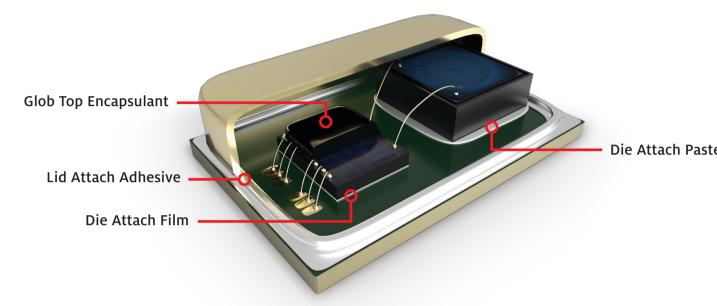
For trusted, proven MEMS materials, a full-solutions approach, quick materials delivery for fast production ramp-up, supply chain simplification, global support and capability, along with an expert, knowledgeable team, Henkel is the obvious – and only – choice.



MEMS Application Overview

Microphones, Pressure Sensors

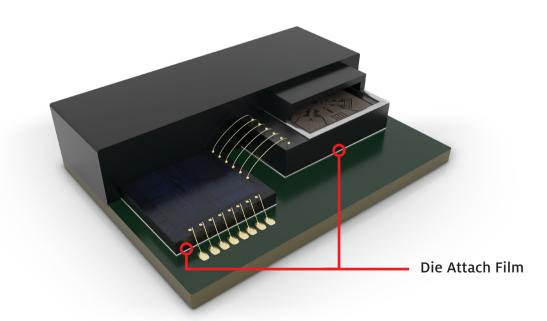
Henkel has a full portfolio of proven materials for a range of processes from die attach to underfill to lid attach and glob top. And Henkel's global support structure ensures quick delivery of Henkel materials around the globe for just about any MEMS application.



MEMS Application Overview

Accelerometers, Gyroscopes, Magnetometers

Henkel provides multiple materials for quick evaluation and testing. This, combined with Henkel's global infrastructure, ensures expert on-site worldwide technical support.



Henkel's MEMS Material Portfolio

Application		Products	Description	at 25°C (MPa)	at 250°((MPa)
ASIC Attach or MEMS Attach	Non- Conductive Paste	LOCTITE® <i>ABLESTIK</i> QMI536NB	Low stress and low moisture absorption, no bleed	300	76
		LOCTITE ABLESTIK QMI538NB		100	30
		LOCTITE ABLESTIK ABP 8142B	Ultra low stable modulus across reflow temperature	2.8	3
	Non-Conductive Paste Print B-Stage	LOCTITE ABLESTIK 8006NS	B-stageable, wafer backside coating, fillet control	4,400	70
		LOCTITE ABLESTIK 6202CX	B-stageable, printed BOC, fillet control	900	6
ASIC Attach	Non- Conductive Film B-Stage	LOCTITE ABLESTIK ATB F125E	DDAF, compatible with non-UV and UV dicing tape, very good laser / SDBG performance, suitable for < 3 mm x 3 mm die	5,256	185
		LOCTITE ABLESTIK ATB 120HA	Low modulus DDAF, laser & stealth dice able, suitable for > 3 mm x 3 mm die	2,299	8.3
ASIC Attach or MEMS Attach	Conductive Paste	LOCTITE ABLESTIK ABP 8060T	High thermal and electrical conductivity, high die shear strength	6,230	1,730
		LOCTITE ABLESTIK 8290	High reliability and good adhesion on different surfaces	3,034	117
Lid or Cap Attach	Non- Conductive Paste	LOCTITE ABLESTIK 3128	Low cure temperature and good adhesion on different surfaces including LCP	3,900	N/A
		LOCTITE ABLESTIK 8387B	High adhesion, fast cure, low weight loss	1,400	53
Lid or Cap Attach	Conductive Paste	LOCTITE ABLESTIK CE3920	Sn compatible, stable adhesion after 5X reflow, low weight loss	5,000	110
		LOCTITE ABLESTIK ABP 2032S	High adhesion on Au and steel, low temperature curable	4,600	150
		LOCTITE ABLESTIK 84-1LMISR4	Good adhesion on different surfaces	3,900	300
Lid or Cap Attach	Conductive Paste Print B-stage	LOCTITE ABLESTIK 8007	Stencil printable, B-stageable, good thermal and electrical conductivity	5,792	272
		LOCTITE ABLESTIK 8008MD		3,880	440
Lid or Cap Attach	Solder Paste	LOCTITE GC 10	Pb-free, no-clean, halogen-free, RT storage, long term stability	N/A	N/A
Glob Top	Non- Conductive Liquid	LOCTITE ECCOBOND FP 4802	Good flow, 260°C compatible	13,000	N/A
		LOCTITE STYCAST EO 1058	High T _g , low CTE	4,800	N/A
Underfill	Non- Conductive Liquid	LOCTITE ECCOBOND UF 8830S	Good flow with self filleting, bleeding control, 260°C compatible	11,500	350
	Non- Conductive Paste	LOCTITE ECCOBOND FP 5201	Self fluxing, high T _g , low CTE	5,800	N/A

